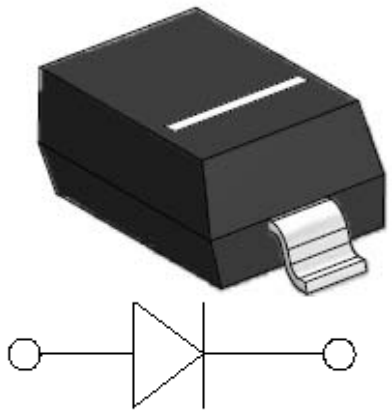
Small Signal Schottky Diode



Features

- V_R 30V
- I_{FAV} 200mA

Mechanical Data

- **Package**: SOD-323
- **Terminals**: Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end
- **Marking:** S8

■Maximum Ratings (Ta=25℃ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	Conditions	VALUE
Repetitive peak reverse voltage	V_{RRM}	V	I_R=100uA	30
Non-Repetitive Peak Forward Surge Current	I_{FSM}	A	t_p=8.3ms	4
Repetitive Peak Forward Current	I_{FRM}	A	tp=1ms， δ =0.25	2
Average forward current	I_{FAV}	mA		200
Power dissipation	P_D	mW		200
Thermal Resistance	R_{thJA}	℃/W		500
Junction temperature	T_j	℃		125
Storage temperature range	T_{stg}	℃		-55 to +150

■Electrical Characteristics（Ta=25℃ Unless otherwise specified）

PARAMETER	SYMBOL	UNIT	Conditions	VALUE
Maximum Forward voltage	V_F	V	I_F=2mA	0.33
		V	I_F=15mA	0.45
		V	I_F=200mA	1
Maximum Reverse current	I_R	uA	V_R=25V	0.5
Minimum Breakdown voltage	V_R	V	I_R=100μA	30
Maximum Diode capacitance	C_D	pF	V_R=1V, f =1MH$_Z$	10

■Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
BAT43WS	F2	Approximate 0.0048	3000	30000	120000	7” reel

■ Characteristics (Typical)

Fig 1：Typical Forward Characteristics

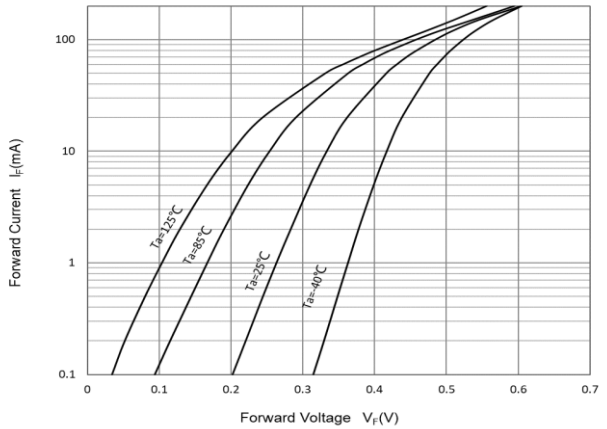


Fig 2：Typical Reverse Characteristics

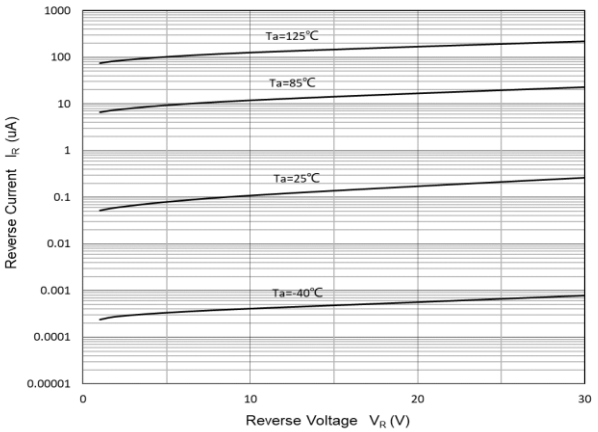
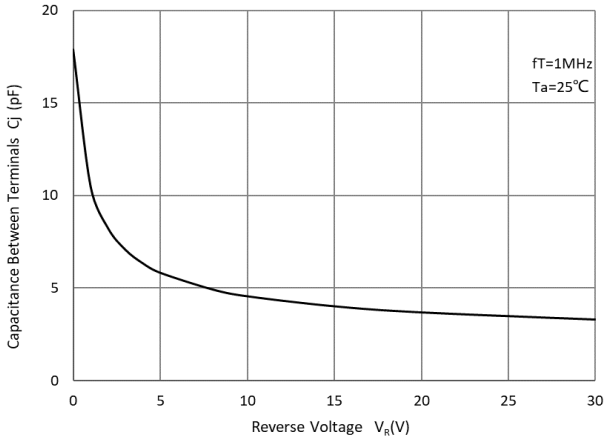
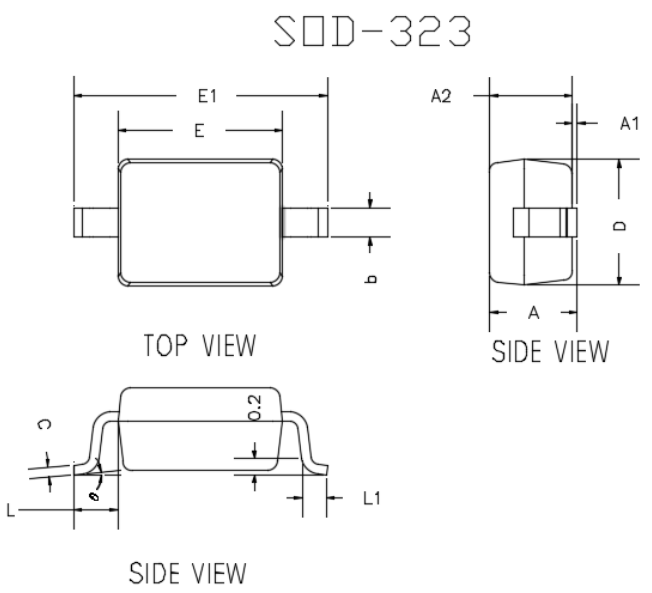


Fig 3：Capacitance Capability



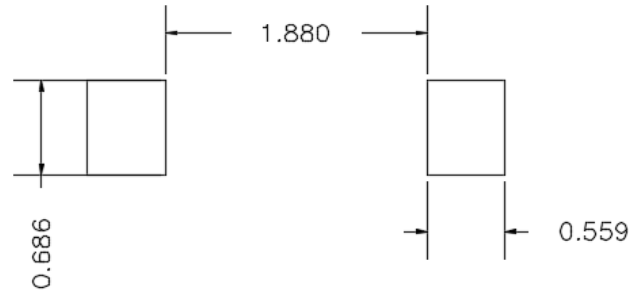
■Outline Dimensions



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MN	MAX
A	---	0.0393	---	1.0000
A1	0.0000	0.0039	0.0000	0.1000
A2	0.0314	0.0354	0.8000	0.9000
b	0.0098	0.0157	0.2500	0.4000
c	0.0031	0.0059	0.0800	0.1500
D	0.0472	0.0551	1.2000	1.4000
E	0.0629	0.0709	1.6000	1.8000
E1	0.0984	0.1063	2.5000	2.7000
L	0.0187TYP		0.475TYP	
L1	0.0098	0.0157	0.250	0.400
θ	0°	8°	0°	8°

Note:
1. All dimensions are in millimeters (mm) unless otherwise specified.
[所有尺寸均以毫米为单位，除非另有说明]
2. General tolerances: ±0.10mm unless otherwise specified.
[通用公差为±0.10mm，除非另有说明]
3. Dimensions and tolerances per ASME Y14.5M-2018.
[尺寸和公差遵循 ASME Y14.5M-2018 标准]
4.All dimensions shown are exclusive of burrs and gate residues.
Burrs and gate vestiges shall not exceed 0.15 mm in maximum.
[所有尺寸均不包括毛刺和浇口残留。毛刺与浇口残留的尺寸最大不得超过 0.15mm]
5.Dimension b does not include dambar protrusion of max 0.100 mm per side.
[尺寸b不包括单边最大0.100 MM的中筋凸出部分]
6.Dimensions D and E are the overall extreme outer dimensions of the mold compound. These dimensions exclude mold flash, lead flash, protrusions and burrs but include the maximum allowable mold mismatch.
[D和E是塑封体的外部极限尺寸，不包括包封溢料、内引线溢料、凸出部分以及胶体毛刺，但是包含了包封错位的最大尺寸]
7.Formed leads shall be planar with respect to one another within a maximum of 0.076 mm relative to the seating plane.
[成型的管脚应为同一平面，共面性最大为0.1mm]

■Soldering Footprint



UNIT: mm

SUGGESTED SOLDER PAD LAYOUT

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